

# DuPont™ SAC™ EKC652™

## Semi-Aqueous Chemistry Remover

### Product Description

DuPont™ SAC™ EKC652™ semi-aqueous chemistry remover is an advanced chemistry formulation that removes post-etch residue quickly and effectively from substrates containing traditional integration materials.

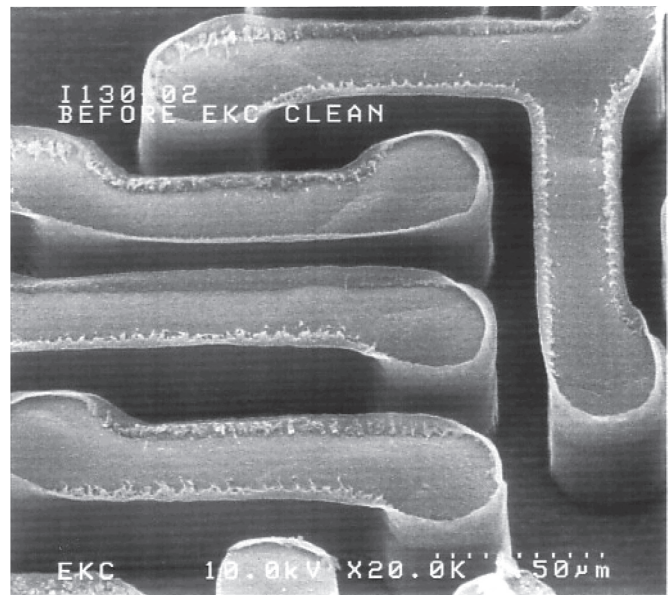
### Application

EKC652™ is specifically designed to remove post-etch residue from traditional integration materials in either wet bench or batch spray operation. It enables high yield production of 250 nm and below semiconductor devices.

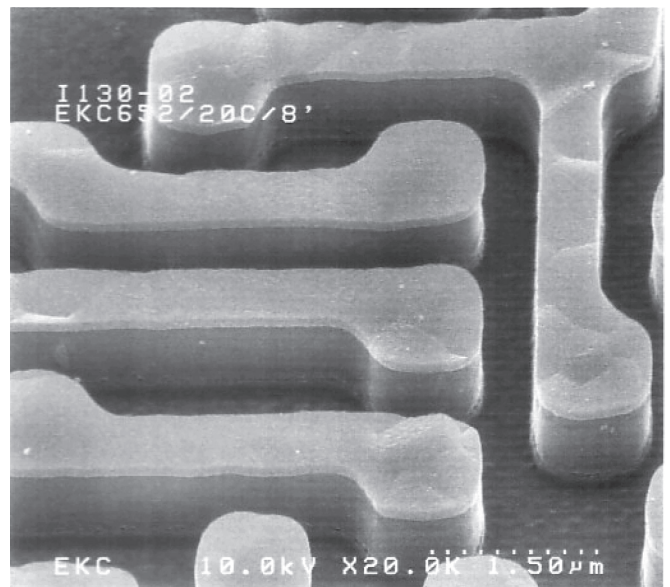
### Product Performance

- Ideally suited for devices with critical dimensions  $\leq 250$  nm
- Compatible with a variety of traditional integration materials
- Good bath life and low Cost of Ownership
- Operates well in a variety of equipment, wet bench or batch spray
- Enables processing through improved device electrical performance
- Smaller environmental footprint solution

**Figure 1. Before cleaning with DuPont™ SAC™ EKC652™ semi-aqueous chemistry remover**



**Figure 2. After cleaning with DuPont™ SAC™ EKC652™ semi-aqueous chemistry remover (8 min, 20 °C)**





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For more information on DuPont™ SAC™ EKC652™ or other DuPont products, please visit our website.

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